



**THE DATASHEET OF  
74HCT14DR2G**



# 74HCT14

## Hex Schmitt-Trigger Inverter with LSTTL Compatible Inputs

### High-Performance Silicon-Gate CMOS

The 74HCT14 may be used as a level converter for interfacing TTL or NMOS outputs to high-speed CMOS inputs.

The HCT14 is useful to “square up” slow input rise and fall times. Due to the hysteresis voltage of the Schmitt trigger, the HCT14 finds applications in noisy environments.

#### Features

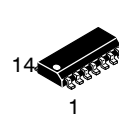
- Output Drive Capability: 10 LSTTL Loads
- TTL/NMOS-Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1.0  $\mu$ A
- In Compliance With the JEDEC Standard No. 7A Requirements
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 72 FETs or 18 Equivalent Gates
- These are Pb-Free Devices



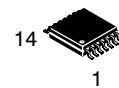
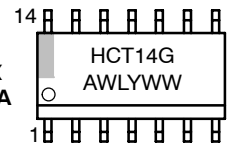
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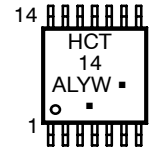
#### MARKING DIAGRAMS



SOIC-14  
D SUFFIX  
CASE 751A



TSSOP-14  
DT SUFFIX  
CASE 948G



HCT14 = Device Code  
A = Assembly Location  
L, WL = Wafer Lot  
Y = Year  
W, WW = Work Week  
G or ■ = Pb-Free Package

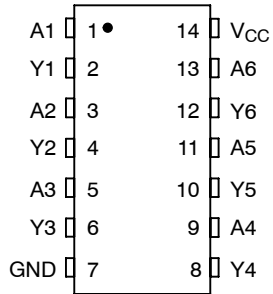
(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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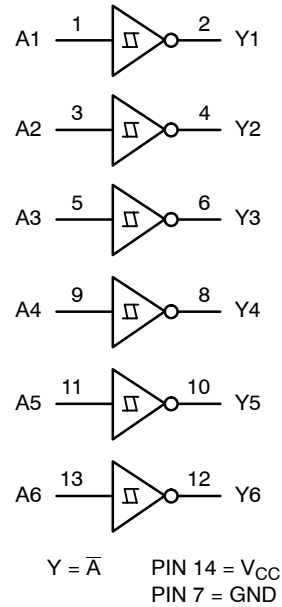
## PIN ASSIGNMENT



## FUNCTION TABLE

Input A	Output Y
L	H
H	L

## LOGIC DIAGRAM



## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
74HCT14DR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
74HCT14DTR2G	TSSOP-14*	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*This package is inherently Pb-Free.

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## MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)	- 0.5 to + 7.0	V
$V_I$	DC Input Voltage (Referenced to GND)	- 0.5 to $V_{CC} + 0.5$	V
$V_O$	DC Output Voltage (Referenced to GND)	- 0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	DC Input Diode Current	$\pm 20$	mA
$I_{OK}$	DC Output Diode Current	$\pm 25$	mA
$I_O$	DC Output Sink Current	$\pm 25$	mA
$I_{CC}$	DC Supply Current per Supply Pin	$\pm 50$	mA
$I_{GND}$	DC Ground Current per Ground Pin	$\pm 50$	mA
$T_{STG}$	Storage Temperature Range	- 65 to + 150	$^{\circ}C$
$T_L$	Lead Temperature, 1 mm from Case for 10 Seconds	260	$^{\circ}C$
$T_J$	Junction Temperature under Bias	+ 150	$^{\circ}C$
$\theta_{JA}$	Thermal Resistance	SOIC TSSOP 125 170	$^{\circ}C/W$
$P_D$	Power Dissipation in Still Air at 85 $^{\circ}C$	SOIC TSSOP 500 450	mW
MSL	Moisture Sensitivity	Level 1	
$F_R$	Flammability Rating	Oxygen Index: 30% - 35% UL 94 V-0 @ 0.125 in	
$V_{ESD}$	ESD Withstand Voltage	Human Body Model (Note 1) Machine Model (Note 2) >2000 >200	V
$I_{Latchup}$	Latchup Performance	Above $V_{CC}$ and Below GND at 85 $^{\circ}C$ (Note 3)	$\pm 300$ mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Tested to EIA/JESD22-A114-A.
2. Tested to EIA/JESD22-A115-A.
3. Tested to EIA/JESD78.
4. For high frequency or heavy load considerations, see the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
$V_I, V_O$	DC Input Voltage, Output Voltage (Referenced to GND)	0	$V_{CC}$	V
$T_A$	Operating Temperature, All Package Types	- 55	+ 125	$^{\circ}C$
$t_r, t_f$	Input Rise and Fall Time (Figure 1)	-	(Note 5)	ns

5. No Limit when  $V_I \approx 50\% V_{CC}$ ,  $I_{CC} > 1$  mA.
6. Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

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## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V <sub>CC</sub> (V)	Temperature Limit						Unit
				-55°C to 25°C		≤ 85°C		≤ 125°C		
				Min	Max	Min	Max	Min	Max	
V <sub>T+</sub> max	Maximum Positive-Going Input Threshold Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5		1.9 2.1		1.9 2.1		1.9 2.1	V
V <sub>T+</sub> min	Minimum Positive-Going Input Threshold Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5	1.2 1.4		1.2 1.4		1.2 1.4		V
V <sub>T-</sub> max	Maximum Negative-Going Input Threshold Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5		1.2 1.4		1.2 1.4		1.2 1.4	
V <sub>T-</sub> min	Minimum Negative-Going Input Threshold Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5	0.5 0.6		0.5 0.6		0.5 0.6		
V <sub>H</sub> max	Maximum Hysteresis Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5		1.4 1.5		1.4 1.5		1.4 1.5	
V <sub>H</sub> min	Minimum Hysteresis Voltage	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V  I <sub>out</sub>   ≤ 20 μA	4.5 5.5	0.4 0.4		0.4 0.4		0.4 0.4		
V <sub>OH</sub>	Minimum High-Level Output Voltage	V <sub>I</sub> < V <sub>T-</sub> min  I <sub>out</sub>   ≤ 20 μA	4.5 5.5	4.4 5.4		4.4 5.4		4.4 5.4		V
		V <sub>I</sub> < V <sub>T-</sub> min  I <sub>out</sub>   ≤ 4.0 mA	4.5	3.98		3.84		3.7		
V <sub>OL</sub>	Maximum Low-Level Output Voltage	V <sub>I</sub> ≥ V <sub>T+</sub> max  I <sub>out</sub>   ≤ 20 μA	4.5 5.5		0.1 0.1		0.1 0.1		0.1 0.1	V
		V <sub>I</sub> ≥ V <sub>T+</sub> max  I <sub>out</sub>   ≤ 4.0 mA	4.5		0.26		0.33		0.4	
I <sub>IK</sub>	Maximum Input Leakage Current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5		±0.1		±1.0		±1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current (per package)	V <sub>I</sub> = V <sub>CC</sub> or GND I <sub>out</sub> = 0 μA	5.5		2.0		20		40	μA
ΔI <sub>CC</sub>	Additional Quiescent Supply Current	V <sub>I</sub> = 2.4 V, Any One Input V <sub>I</sub> = V <sub>CC</sub> or GND, Other Inputs I <sub>out</sub> = 0 μA	5.5	≥ -55°C		25°C to 125°C				mA
				2.9		2.4				

7. Information on typical parametric values can be found in the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

## AC CHARACTERISTICS (C<sub>L</sub> = 50 pF; Input t<sub>r</sub> = t<sub>f</sub> = 6.0 ns)

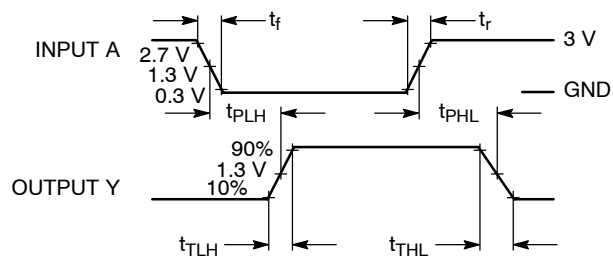
Symbol	Parameter	Test Conditions	Figures	Guaranteed Limit						Unit
				-55°C to 25°C		≤ 85°C		≤ 125°C		
				Min	Max	Min	Max	Min	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, Input A to Output Y (L to H)	V <sub>CC</sub> = 5.0 V ± 10% C <sub>L</sub> = 50 pF, Input t <sub>r</sub> = t <sub>f</sub> = 6.0 ns	1 & 2		32		40		48	ns
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Transition Time, Any Output	V <sub>CC</sub> = 5.0 V ± 10% C <sub>L</sub> = 50 pF, Input t <sub>r</sub> = t <sub>f</sub> = 6.0 ns	1 & 2		15		19		22	ns

8. For propagation delays with loads other than 50 pF, and information on typical parametric values, see the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

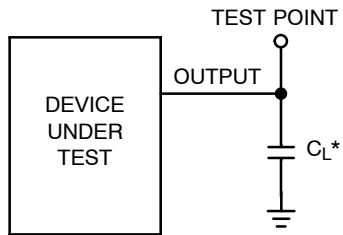
C <sub>PD</sub>	Power Dissipation Capacitance, per Inverter (Note 9)	Typical @ 25°C, V <sub>CC</sub> = 5.0 V		pF
		32		

9. Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>. For load considerations, see the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

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**Figure 1. Switching Waveforms**



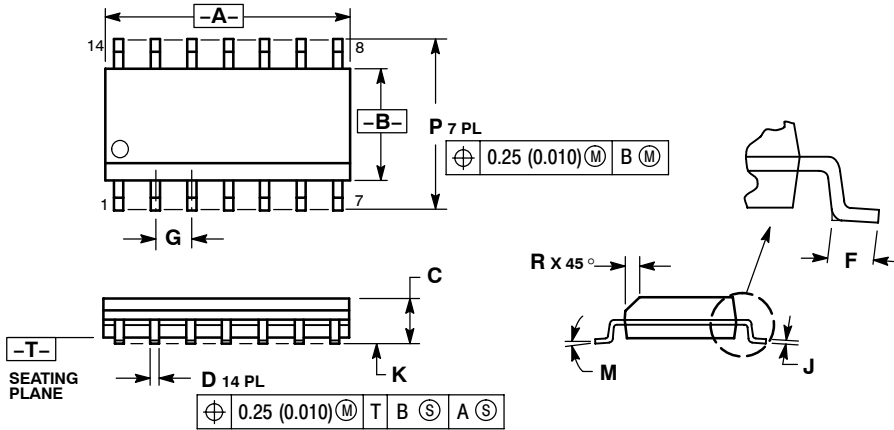
\*Includes all probe and jig capacitance.

**Figure 2. Test Circuit**

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## PACKAGE DIMENSIONS

SOIC-14  
CASE 751A-03  
ISSUE H

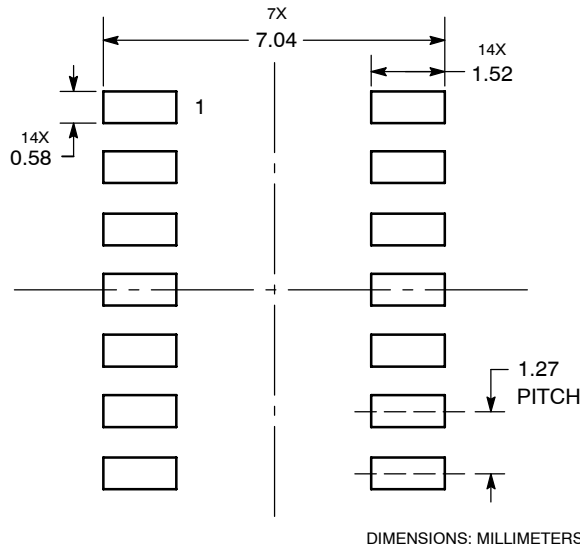


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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